

WST3407-VB Datasheet P-Channel 30-V (D-S) MOSFET

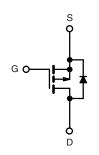
PRODUCT SUMMARY						
V _{DS} (V)	R_{DS(on)} (Ω)	I _D (A) ^{a, e}	Q _g (Typ.)			
- 30	0.060 at V _{GS} = - 10 V	- 5.0	7 nC			
	0.075 at V _{GS} = - 4.5 V	- 4.6	7 110			

FEATURES

- Halogen-free According to IEC 61249-2-21 Definition
- TrenchFET[®] Power MOSFET
- 100 % R_g Tested
 Compliant to RoHS Directive 2002/95/EC

APPLICATIONS

- · Load Switch
- Notebook Adaptor Switch
- DC/DC Converter



P-Channel MOSFET

ABSOLUTE MAXIMUM RATINGS $T_A = 25 \text{ °C}$, unless otherwise noted					
Parameter		Symbol	Limit	Unit	
Drain-Source Voltage		V _{DS}	- 30	v	
Gate-Source Voltage		V _{GS}	± 20	v	
	T _C = 25 °C		- 5.0		
Continuous Drain Current (T 150 °C)	T _C = 70 °C	I _D	- 4.7		
Continuous Drain Current ($T_J = 150 \ ^{\circ}C$)	T _A = 25 °C		- 4.2 ^{b, c}		
	T _A = 70 °C		- 3.3 ^{b, c}	А	
Pulsed Drain Current		I _{DM}	- 25		
Continuus Courses Ducin Diado Current	T _C = 25 °C	1	- 2.1		
Continous Source-Drain Diode Current	T _A = 25 °C	I _S	- 1 ^{b, c}		
Maximum Power Dissipation	T _C = 25 °C	- P _D	2.5		
	T _C = 70 °C		1.6	w	
	T _A = 25 °C		1.25 ^{b, c}	vv	
	T _A = 70 °C	1	0.8 ^{b, c}	1	
Operating Junction and Storage Temperature Range		T _J , T _{stg}	- 55 to 150	°C	

THERMAL RESISTANCE RATINGS

Parameter		Symbol	Typical	Maximum	Unit		
Maximum Junction-to-Ambient ^{b, d}	$t \le 5 s$	R _{thJA}	75	100	°C/W		
Maximum Junction-to-Foot (Drain)	Steady State	R _{thJF}	40	50	C/W		

Notes:

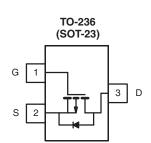
a. Based on $T_C = 25 \ ^{\circ}C$.

b. Surface Mounted on 1" x 1" FR4 board.

c. t = 5 s.

d. Maximum under Steady State conditions is 166 °C/W.

e. Package Limited.





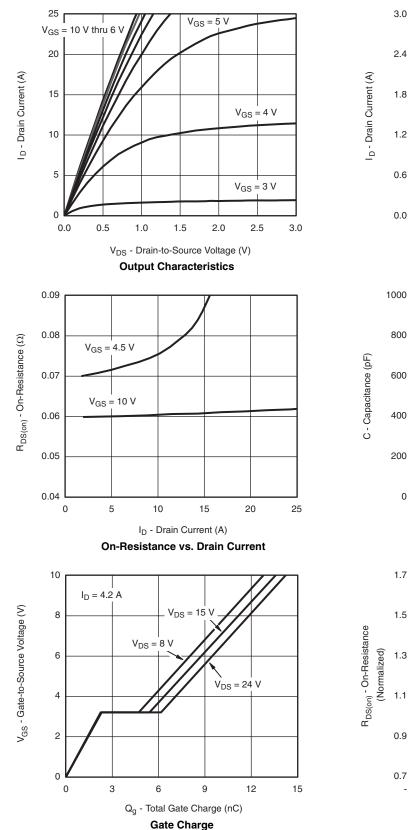
Parameter	Symbol	Test Conditions	Min.	Тур.	Max.	Unit	
Static		· · · · · · · · · · · · · · · · · · ·					
Drain-Source Breakdown Voltage	V _{DS}	$V_{GS} = 0 V, I_D = -250 \mu A$	- 30			V	
V _{DS} Temperature Coefficient	$\Delta V_{DS}/T_{J}$	- I _D = - 250 μΑ		- 19		mV/°C	
V _{GS(th)} Temperature Coefficient	$\Delta V_{GS(th)}/T_J$			4.4			
Gate-Source Threshold Voltage	V _{GS(th)}	$V_{DS} = V_{GS}$, $I_D = -250 \ \mu A$	- 1.0		- 2.5	V	
Gate-Source Leakage	I _{GSS}	$V_{DS} = 0 V, V_{GS} = \pm 20 V$			± 100	nA	
Zara Cata Valtaga Drain Current	I _{DSS}	$V_{DS} = -30 \text{ V}, \text{ V}_{GS} = 0 \text{ V}$			- 1	- 1 - 5 μΑ	
Zero Gate Voltage Drain Current		$V_{DS} = -30 \text{ V}, \text{ V}_{GS} = 0 \text{ V}, \text{ T}_{J} = 55 ^{\circ}\text{C}$			- 5		
On-State Drain Current ^a	I _{D(on)}	$V_{DS} \le$ - 5 V, V_{GS} = - 10 V	- 25			Α	
Drain Sauras On State Desistance	Para	V _{GS} = - 10 V, I _D = - 4.2 A		0.060		Ω	
Drain-Source On-State Resistance ^a	R _{DS(on)}	$V_{GS} = -4.5 \text{ V}, \text{ I}_{D} = -3.2 \text{ A}$		0.075			
Forward Transconductance ^a	9 _{fs}	V _{DS} = - 15 V, I _D = - 4.2 A		10		S	
Dynamic ^b		· · · · · · · · · · · · · · · · · · ·					
Input Capacitance	C _{iss}			590		pF	
Output Capacitance	C _{oss}	V _{DS} = - 15 V, V _{GS} = 0 V, f = 1 MHz		115			
Reverse Transfer Capacitance	C _{rss}			93			
Total Gate Charge	Q _g Q _{gs}	V_{DS} = - 15 V, V_{GS} = - 10 V, I_D = - 4.2 A		13.6	21	nC	
Total Gate Charge		V _{DS} = - 15 V, V _{GS} = - 4.5 V, I _D = - 4.2 A		7	11		
Gate-Source Charge				2.3			
Gate-Drain Charge	Q _{gd}			3.2			
Gate Resistance	Rg	f = 1 MHz	1	5	10	Ω	
Turn-On Delay Time	t _{d(on)}			30	45		
Rise Time	t _r	$V_{DD} = -15 \text{ V}, \text{ R}_{L} = 4.5 \Omega$ $\text{I}_{D} \cong -3.3 \text{ A}, \text{ V}_{\text{GEN}} = -4.5 \text{ V}, \text{ R}_{g} = 1 \Omega$		25	38		
Turn-Off Delay Time	t _{d(off)}			16	24		
Fall Time	t _f			8	16		
Furn-On Delay Time t _{d(on)}				8	16	ns	
Rise Time	t _r	$V_{DD} = -15$ V, R _L = 4.5 Ω $I_D \cong -3.3$ A, V _{GEN} = -10 V, R _g = 1 Ω		10	20	-	
Turn-Off Delay Time	t _{d(off)}			18	27		
Fall Time	t _f	1 1		8	16		
Drain-Source Body Diode Characteristic	cs				•		
Continuous Source-Drain Diode Current	۱ _S	T _C = 25 °C			- 4.2	۸	
Pulse Diode Forward Current	I _{SM}				- 25	A	
Body Diode Voltage	V _{SD}	I _S = - 3.3 A, V _{GS} = 0 V		- 0.8	- 1.2	V	
Body Diode Reverse Recovery Time t _{rr}				17	26	ns	
Body Diode Reverse Recovery Charge	Q _{rr}			9	18	nC	
Reverse Recovery Fall Time	t _a	$I_F = -3.3 \text{ A}, \text{ dl/dt} = 100 \text{ A/}\mu\text{s}, T_J = 25 ^\circ\text{C}$		10		ns	
Reverse Recovery Rise Time	t _b	1 1		7			

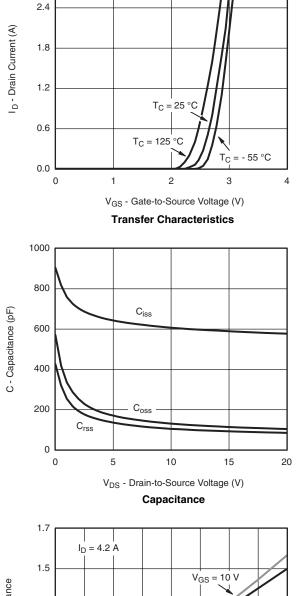
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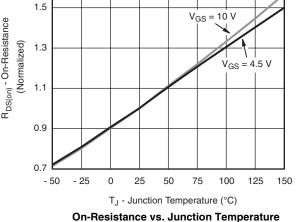
a. Pulse test; pulse width \leq 300 μ s, duty cycle \leq 2 %. b. Guaranteed by design, not subject to production testing.

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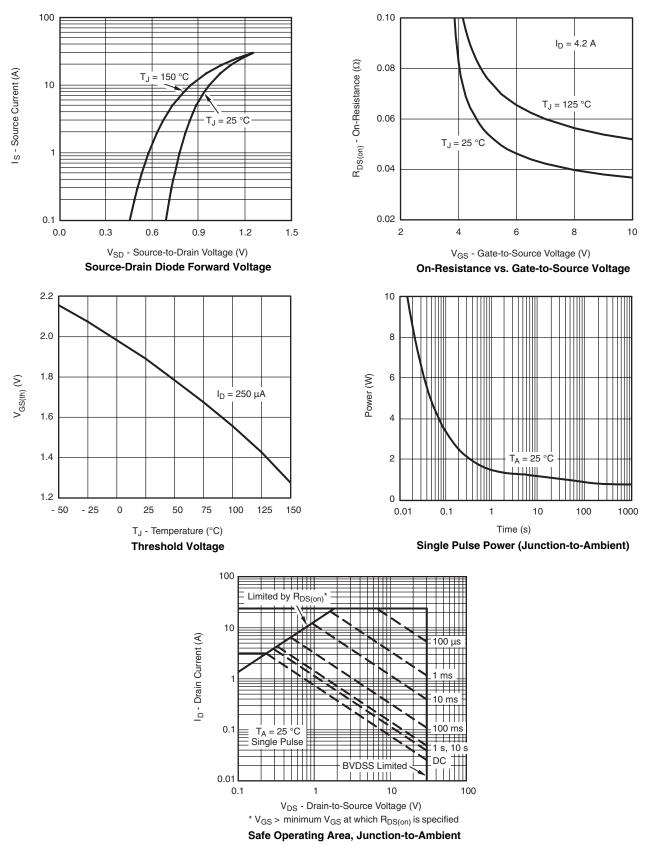




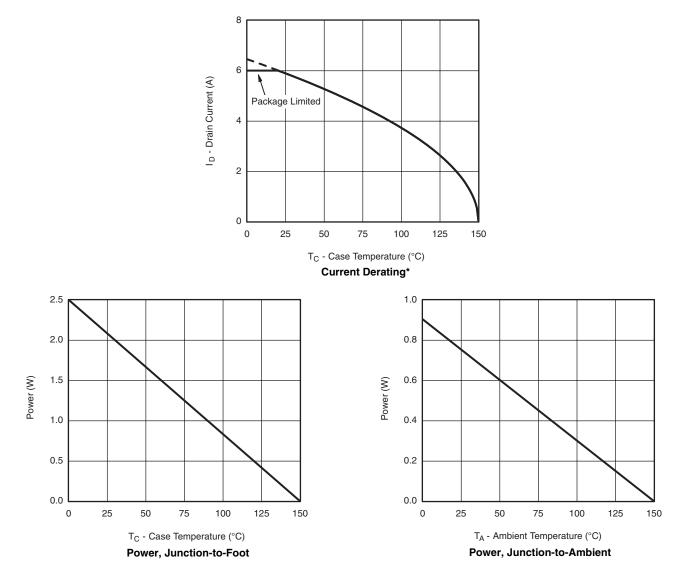


服务热线:400-655-8788



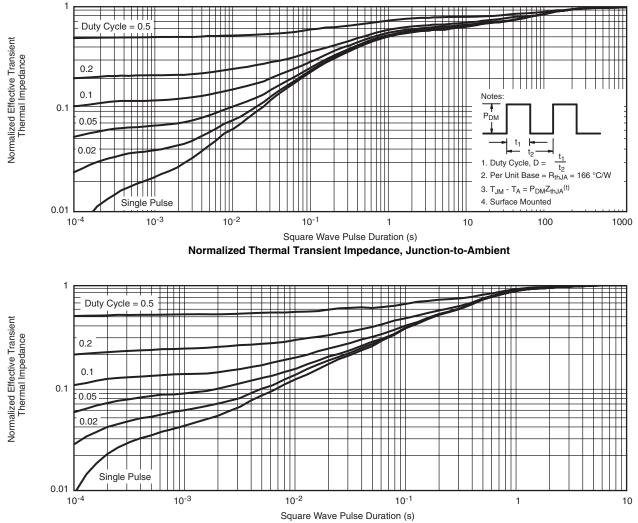






* The power dissipation P_D is based on $T_{J(max)} = 150$ °C, using junction-to-case thermal resistance, and is more useful in settling the upper dissipation limit for cases where additional heatsinking is used. It is used to determine the current rating, when this rating falls below the package limit.





Normalized Thermal Transient Impedance, Junction-to-Foot



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